



February 2009



- Pletronics' SM33 Series is a quartz crystal controlled precision square wave generator with a CMOS output.
- The package is designed for high density surface mount designs.
- This is a low cost mass produced oscillator.
- Tape and Reel or cut tape packaging is available.
- 0.75 to 50 MHZ
- 2.0 x 2.5 mm LCC Ceramic Package
- Enable/Disable Function
- Disable function includes low standby power mode
- · Low Jitter

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's

Weight of the Device: 0.022 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020C

Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +7.0V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V
Io Output Current	+25 mA to -25 mA

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 50 to 70°C/Watt depending on the solder pads, ground plane and construction of the PCB.



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Part Number:

SM33	45	Т	E	W	- 7 5.0M	-XX		Part Marking:
							Packaging code or blank T250 = 250 per Tape and Reel T500 = 500 per Tape and Reel T1K = 1000 per Tape and Reel	P <i>FF.FF</i> • <i>YMDxx</i>
							Frequency in MHz	
							Supply Voltage V _{cc} W = 2.5V ± 10%	
							Temperature Range Blank = Temp. range -10 to +70°C E = Temp. range -40 to +85°C	
							Series Model	
							Frequency Stability 44 = ± 25 ppm 45 = ± 50 ppm 00 = ± 100 ppm	
							Series Model	

Marking Legend:

P = Pletronics

FF.FF = Frequency in MHZ

YMD = Date of Manufacture (year and week, or year-month-day)

All other marking is internal factory codes

Specifications such as frequency stability, supply voltage and operating temperature range, etc. are not identified from the marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD

Code	8	9	0	1	2	
Year	2008	2009	2010	2011	2012	

Code	Α	В	C	D	Е	F	G	Н	J	K	L	М
Month	JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC

Code	1	2	3	4	5	6	7	8	9	Α	В	С
Day	1	2	3	4	5	6	7	8	9	10	11	12
Code	D	E	F	G	Н	J	K	L	М	N	Р	R
Day	13	14	15	16	17	18	19	20	21	22	23	24
Code	Т	U	V	W	Х	Y	Z					
Day	25	26	27	28	29	30	31					

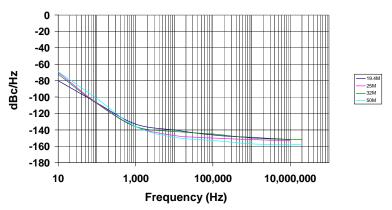


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Electrical Specification for 2.50V ±10% over the specified temperature range

Item	Min	Max	Unit	Condition
Frequency Range	0.75	50	MHz	
Frequency Accuracy "00" "45 "44	-100 -50 -25	100 50 25	ppm	For all supply voltages, load changes, aging for 1 year, shock, vibration and temperatures
Output Waveform		CMOS	3	
Output High Level	90	-	%	of V _{CC} Cload = 15 pF (See load circuit)
Output Low Level	-	10	%	
Rise and Fall Time	-	10	nS	
Output Symmetry	40	60	%	at 50% point of V _{cc}
Enable/Disable Internal Pull-up	50	-	Kohm	to V _{cc}
V disable	-	30	%	of V _{CC} applied to pad 1
V enable	70	-	%	
Output leakage $V_{OUT} = V_{CC}$	-10	+10	uA	Pad 1 low, device disabled
$V_{OUT} = 0V$	-10	+10	uA	
Standby Current I _{CC}	•	10	uA	
Operating Current I _{cc}	-	5 9 11	mA	Fout < 20 MHz 20 MHz >= Fout <40 MHz Fout >= 40MHz
Enable time	-	10	mS	Time for output to reach a logic state
Disable time	-	150	nS	Time for output to reach a high Z state
Start up time	-	10	mS	Time for output to reach specified frequency
Aging	- 5	+5	ppm	First year at 25°C
Operating Temperature Range	-10	+70	°C	Standard Temperature Range
	-40	+85	°C	Extended Temperature Range "E" Option
Storage Temperature Range	-55	+100	°C	

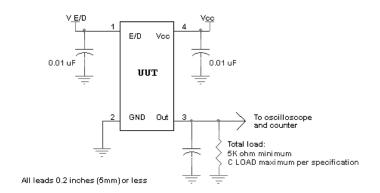
Phase Noise Performance

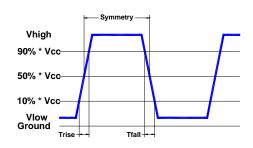




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Load Circuit and Test Waveform





Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	1500	MIL-STD-883 Method 3115
Charged Device Model	1000	JESD 22-C101

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII

P/N: SM4444TW-44.0M

Customer P/N: 12345678

Qty: D/C 7FW-MMO

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

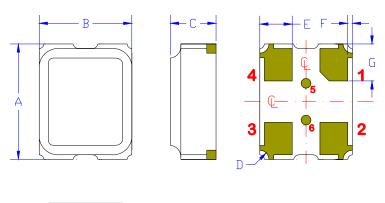
2nd LvL Interconnect Category=e4

Max Safe Temp=260C for 10s 2X Max



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Mechanical:



	Inches	mm
Α	0.098 <u>+</u> 0.004	2.50 <u>+</u> 0.10
В	0.079 <u>+</u> 0.004	2.00 <u>+</u> 0.10
С	0.039 <u>+</u> 0.004	1.00 <u>+</u> 0.10
D ¹	0.008	0.20R
E¹	0.028	0.70
F¹	0.004	0.10
G¹	0.031	0.80

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 μ inches 0.3 μ m minimum over Nickel 50 to 350 μ inches 1.27 to 8.89 μ m

Do not connect pads 5 or pad 6!!!!

Pad	Function	Note
1	Output Enable/Disable	When this pad is not connected the oscillator shall operate. When this pad is logic low the output will be inhibited (high impedance state.) Recommend connecting this pad to $V_{\rm CC}$ if the oscillator is to be always on.
2	Ground (GND)	
3	Output	
4	Supply Voltage (V _{cc})	Recommend connecting appropriate power supply bypass capacitors as close as possible.

Lead free

Layout and application information

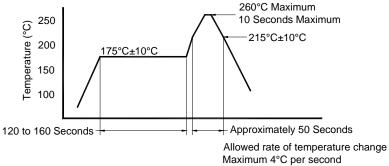
For Optimum Jitter Performance, Pletronics recommends:

- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.



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Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

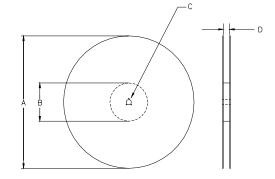
	Constant Dimensions Table 1											
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max				
8mm		1.0			2.0							
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05							
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6		0.1				
24mm		1.5			<u>+</u> 0.1							

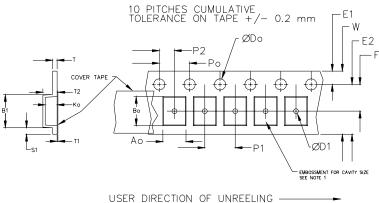
	Variable Dimensions Table 2											
Tape Size							Ao, Bo & Ko					
8 mm 2.9 6.25 1.75±0.1 4.0±0.1 1.1 8.1 Note 1												

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to

Not to scale





Α	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
В	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13.0 +0.5 / -0.2			wiatri
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0

REEL DIMENSIONS

Reel dimensions may vary from the above



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